SM400X SERIES

<u>SURFACE MOUNT GLASS PASSIVATED SILICON RECTIFIER</u>

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SM4001 THRU SM4007

SURFACE MOUNT GLASS PASSIVATED SILICON RECTIFIER



REVERSE VOLTAGE: 50 to 1000 VOLTS FORWARD CURRENT: 1.0 AMPERE

FEATURES

Plastic package has Underwriters Laboratory
 Flammability Classification 94V-O

- · For surface mounted applications
- · High temperature metallurgically bonded construction
- · Cavity-free glass passivated junction
- Capable of meeting environmental standards of MIL-S-19500
- · High temperature soldering: 250°C /10 seconds at terminals

MECHANICAL DATA

Case: Molded plastic, MELF

Epoxy: UL 94V-O rate flame retardant

Terminals: Solder plated, solderable per MIL-STD-750,

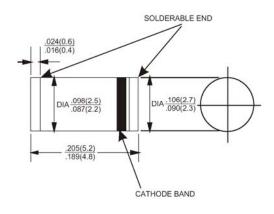
method 208 guaranteed

Polarity: Color band denotes cathode end

Mounting position: Any

Weight: 0.005 ounce, 0.12 gram

MELF



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

	Symbols	SM4001	SM4002	SM4003	SM4004	SM4005	SM4006	SM4007	Units
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current at T_A =75 $^{\circ}$ C	I _(AV)	1.0							Amp
Peak Forward Surge Current,									
8.3ms single half-sine-wave	I_{FSM}	I _{FSM} 30							
superimposed on rated load (JEDEC method)								<u></u>	
Maximum Forward Voltage at 1.0A	$V_{\rm F}$	1.1							Volts
Maximum Reverse Current at T _A =25℃	т.		5. 0						
at Rated DC Blocking Voltage $T_A=125$ °C	I_R	200							μAmp
Typical Junction Capacitance (Note 1)	C_{J}	15							pF
Typical Thermal Resistance (Note 2)	R _{0 JA}	50							°C/W
Typical Thermal Resistance (Note 3)	R _{0 JT}	20							°C/W
Operating Junction Temperature Range	T_{J}	-55 to +175							С
Storage Temperature Range	Tstg	-55 to +175							ဗ

NOTES:

- 1- Measured at 1 MH_Z and applied reverse voltage of 4.0 VDC.
- 2- Thermal resistance from junction to ambient, 0.24 x 0.24" (6.0 x 6.0mm) copper pads to each terminal
- 3- Thermal resistance from junction to terminal, 0.24 x 0.24" (6.0 x 6.0mm) copper pads to each terminal



RATINGS AND CHARACTERISTIC CURVES

Fig. 1 - Forward Current Derating Curve 60Hz Resistive or Average Forward Current (A) Inductive Load 8.0 0.6 0.4 0.2 0 25 100 125 150 175 Terminal Temperature (°C)

Fig. 2 - Maximum Non-Repetitive Peak
Forward Surge Current

30

15

15

10

Number of Cycles at 60Hz

Fig. 3 - Typical Instantaneous
Forward Characteristics

10
Pulse Width = 300µs
1% Duty Cycle

1% Duty Cycle

0.01
0.4
0.6
0.8
1.0
1.2
1.4
1.6
Instantaneous Forward Voltage (V)

